

AP Memory Company Profile

August 26, 2026

AP Memory at a Glance

A Fabless Design Company Providing **Customized Memory and IP Solutions**

Founded in
2011

Headquarters in
Taiwan

230+
Employees

2016
Listed in TWSE (6531)

>9B
Unit Shipped

20+yr
Design Experience

USD 182M
2025 Revenue

Bringing Innovation to Reality



2017-2019

PSRAM for wafer-level packaging in wearables

Discrete DRAM-based Silicon Capacitors ([2] S-SiCap™)

Ultra-High-Speed (UHS) PSRAM for display



2024-2026

S-SiCap™ interposer, S-SiCap™ embedded in substrates

ApSRAM™ for high-performance battery-powered edge devices

2011-2014

[1] PSRAM for system-in-package in mobile phones

Low-pin-count (QSPI/OPI) PSRAM for IoT application



2020-2023

3D integrated DRAM and SoC ([3] VHM™)

VHMStack™ PoC and Product design-ins



An Overview of **AP Memory Products**

IoTRAM™

The Ideal Memory for IoT

Leading in product innovation and market share



Wearable



Smart Lock



LTE Modem

VHM™

The AI/HPC Memory Solution

World's first 3D integration of DRAM and SoC chips



AI Servers



Edge AI



HPC

S-SiCap™

The Performance Enabler

Highest capacitance density for high performance applications



AI Servers



HPC



Smartphone

Business Model



IoTRAM™ Portfolio

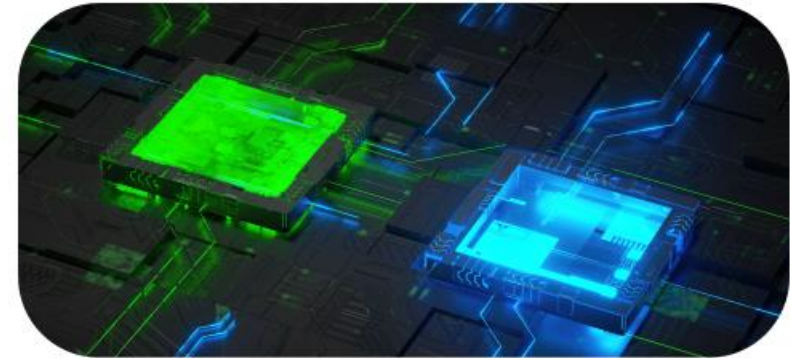
- >90% in Known-Good-Die (KGD) and WLCSP sales

VHM™ Memory Solution

- Design phase: NRE & Licensing of VHM™ IP
- Production phase: Royalty-like VHM™ DRAM wafer sales

S-SiCap™ IP & Products

- Discrete IC and interposers
- IP licensing & Royalty
- Design service and wafer sales



Thank you

Sales Center

Contact : MarCom team

Email: apm_marcom@apmemory.com

For more information, visit us at
<https://www.apmemory.com>